

PMN37ENEX-VB Datasheet

N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY

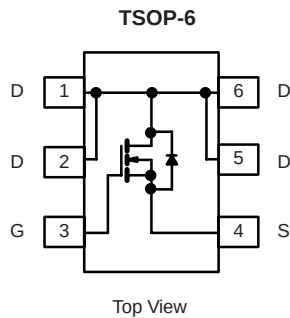
V_{DS} (V)	60
$R_{DS(on)}$ (Ω) at $V_{GS} = 10$ V	0.030
$R_{DS(on)}$ (Ω) at $V_{GS} = 4.5$ V	0.035
I_D (A)	7
Configuration	Single

FEATURES

- Trench power MOSFET
- 100 % R_g and UIS tested



RoHS
COMPLIANT
HALOGEN
FREE



ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current	I_D	$T_C = 25$ °C	7
		$T_C = 125$ °C	4
Continuous Source Current (Diode Conduction)	I_S	6	A
Pulsed Drain Current ^a	I_{DM}	29	
Single Pulse Avalanche Current	I_{AS}	10	
Single Pulse Avalanche Energy	E_{AS}	5	mJ
Maximum Power Dissipation ^a	P_D	$T_C = 25$ °C	5
		$T_C = 125$ °C	1.6
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to +175	°C

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-Ambient	R_{thJA}	110	°C/W
Junction-to-Foot (Drain)	R_{thJF}	30	

Notes

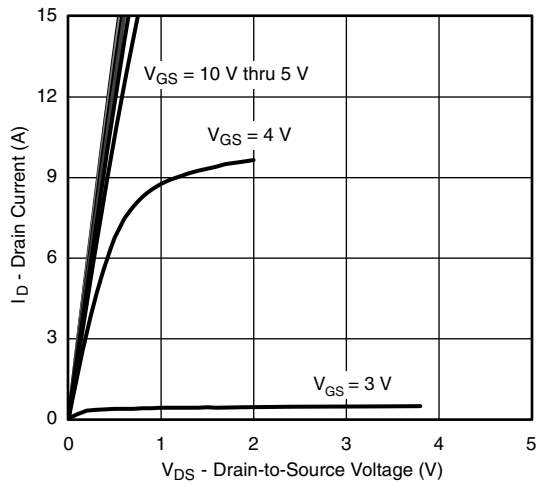
- a. Pulse test; pulse width ≤ 300 μ s, duty cycle ≤ 2 %.
- b. When mounted on 1" square PCB (FR-4 material).

SPECIFICATIONS (T _C = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0, I _D = 250 μA		60	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA		1.0	-	2.5	
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 12 V		-	-	± 500	nA
		V _{DS} = 0 V, V _{GS} = ± 20 V		-	-	± 1	mA
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 60 V	-	-	1	μA
		V _{GS} = 0 V	V _{DS} = 60 V, T _J = 125 °C	-	-	50	
		V _{GS} = 0 V	V _{DS} = 60 V, T _J = 175 °C	-	-	150	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	V _{DS} ≥ 5 V	10	-	-	A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 5 A	-	0.030	-	Ω
		V _{GS} = 10 V	I _D = 5 A, T _J = 125 °C	-	0.050	-	
		V _{GS} = 10 V	I _D = 5 A, T _J = 175 °C	-	0.070	-	
		V _{GS} = 4.5 V	I _D = 4 A	-	0.035	-	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 4 A		-	12	-	S
Dynamic ^b							
Input Capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = 30 V, f = 1 MHz	-	560	700	pF
Output Capacitance	C _{oss}			-	85	105	
Reverse Transfer Capacitance	C _{rss}			-	55	70	
Total Gate Charge ^c	Q _g	V _{GS} = 4.5 V	V _{DS} = 30 V, I _D = 4 A	-	7.6	12	nC
Gate-Source Charge ^c	Q _{gs}			-	2.1	-	
Gate-Drain Charge ^c	Q _{gd}			-	4.1	-	
Gate Resistance	R _g	f = 1 MHz		1.2	2.4	3.6	Ω
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = 30 V, R _L = 7.5 Ω I _D ≅ 4 A, V _{GEN} = 10 V, R _g = 1 Ω		-	9	14	ns
Rise Time ^c	t _r			-	12	18	
Turn-Off Delay Time ^c	t _{d(off)}			-	19	29	
Fall Time ^c	t _f			-	7	11	
Source-Drain Diode Ratings and Characteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	29	A
Forward Voltage	V _{SD}	I _F = 1.6 A, V _{GS} = 0		-	0.75	1.2	V

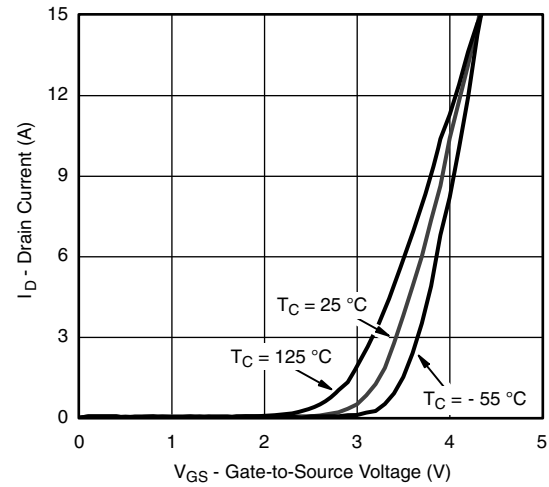
Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
 b. Guaranteed by design, not subject to production testing.
 c. Independent of operating temperature.

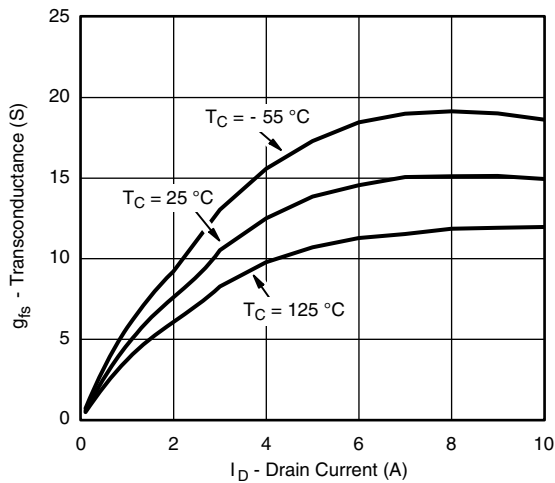
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)


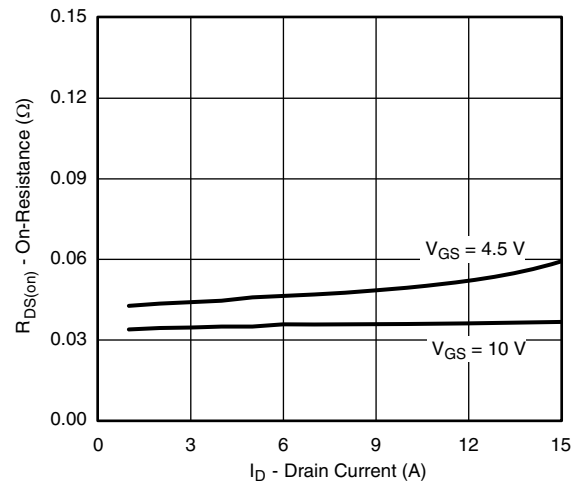
Output Characteristics



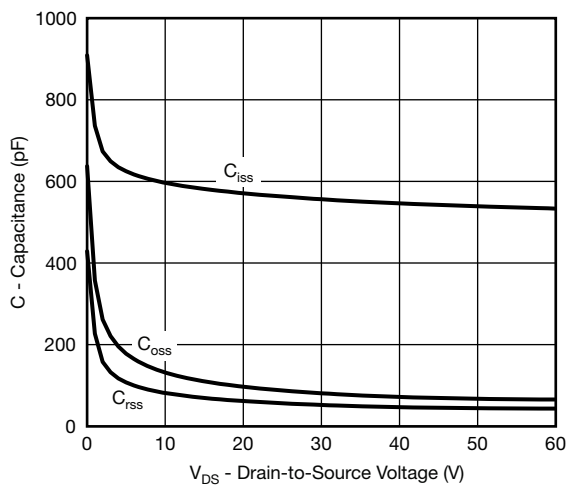
Transfer Characteristics



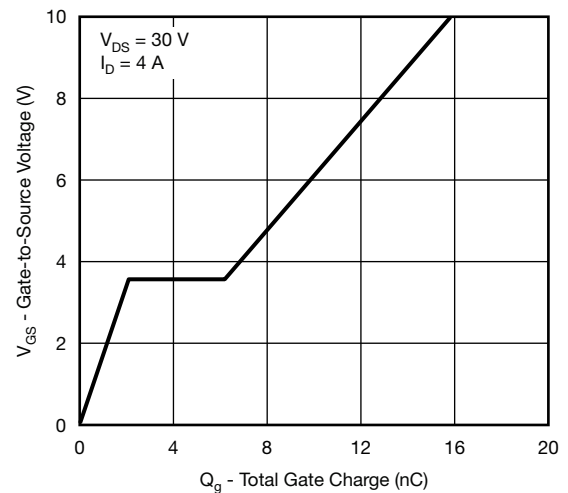
Transconductance



On-Resistance vs. Drain Current

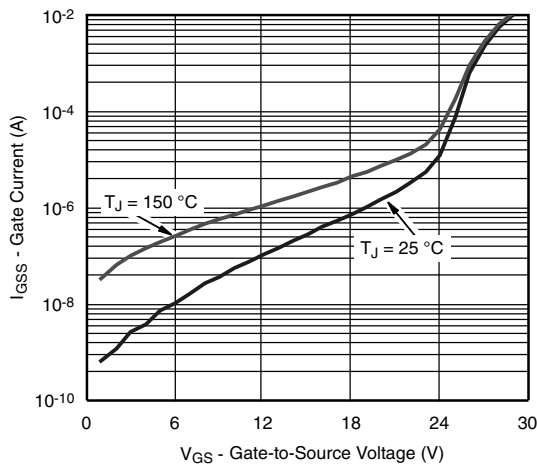


Capacitance

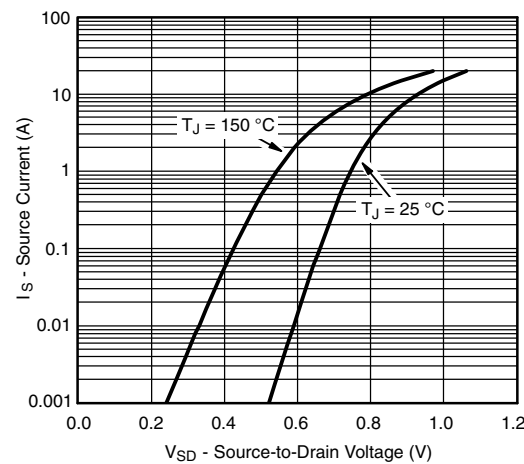


Gate Charge

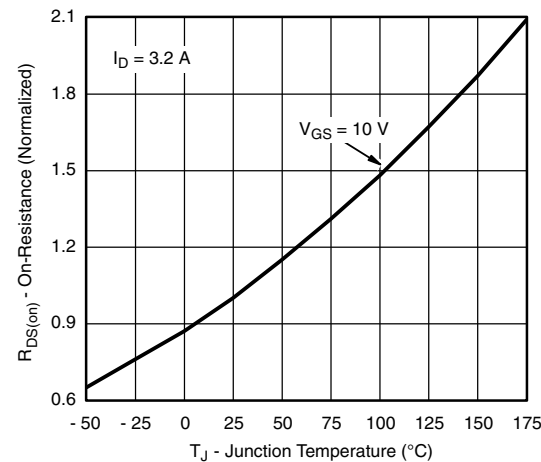
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



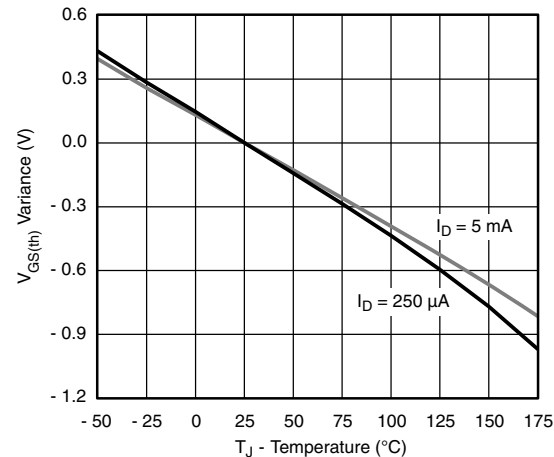
Gate Current vs. Gate-Source Voltage



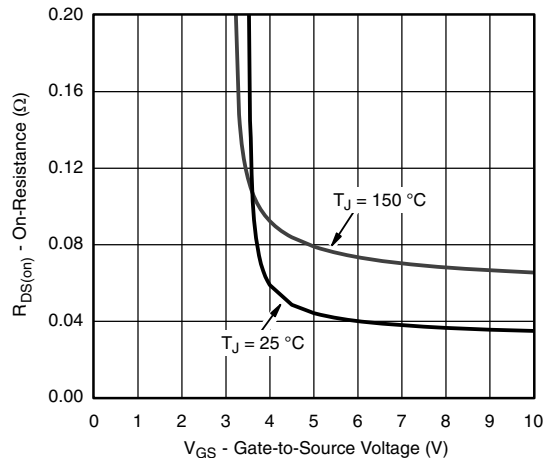
Source-Drain Diode Forward Voltage



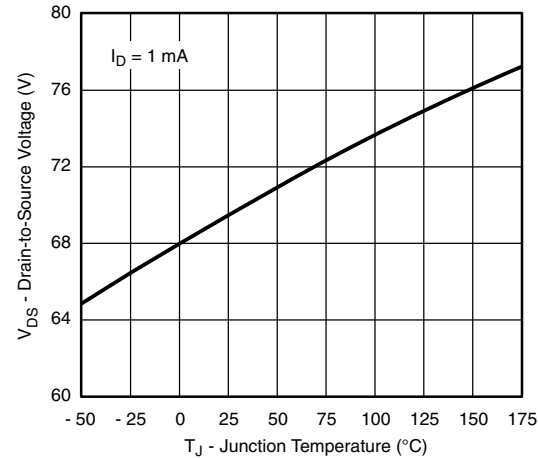
On-Resistance vs. Junction Temperature



Threshold Voltage

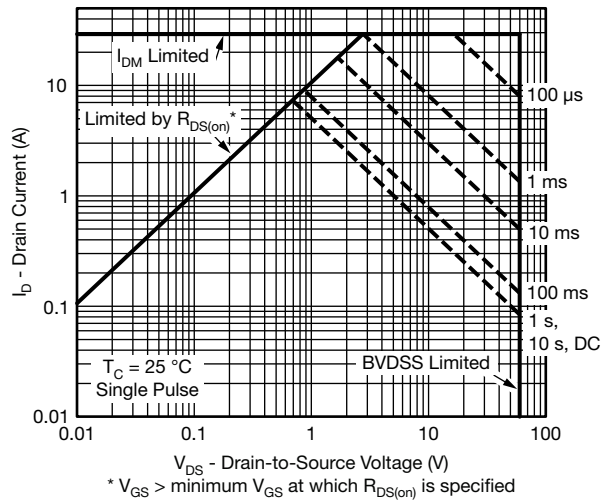


On-Resistance vs. Gate-Source Voltage

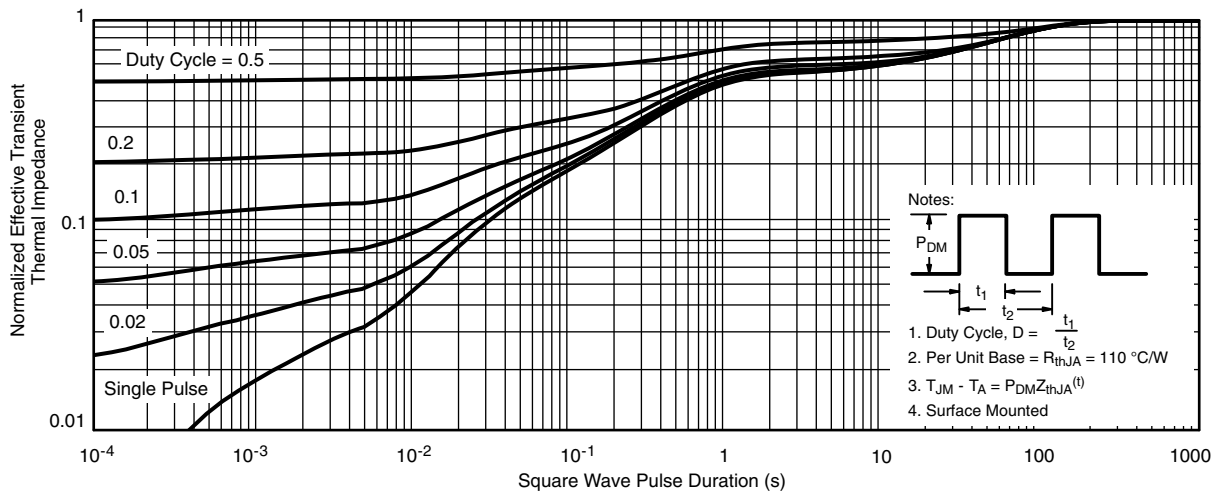


Drain-Source Breakdown vs. Junction Temperature

THERMAL RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

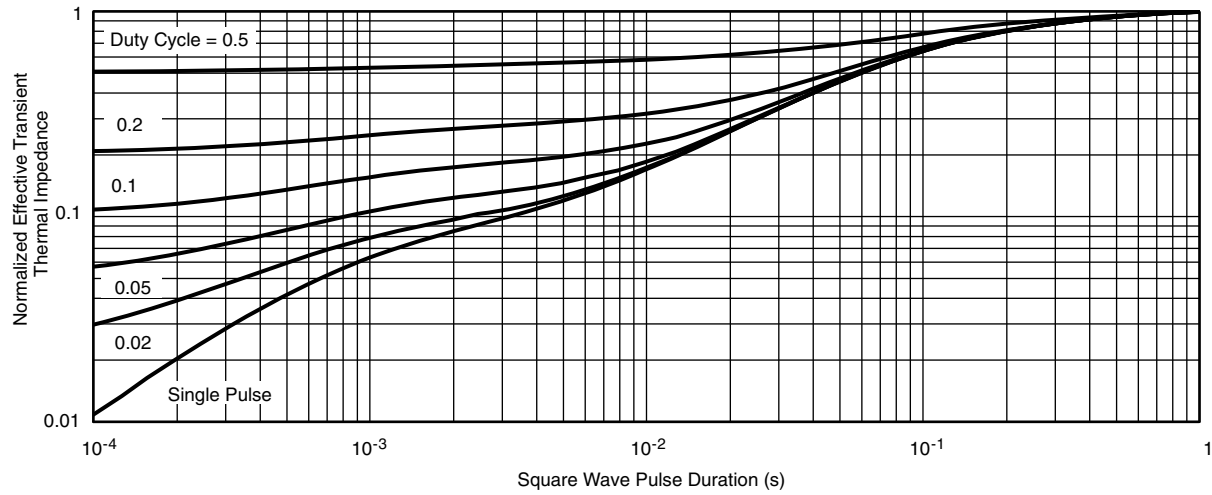


Safe Operating Area



Normalized thermal Transient Impedance, Junction-to-Ambient

THERMAL RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



Normalized thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient ($25\text{ }^{\circ}\text{C}$)
 - Normalized Transient Thermal Impedance Junction to Foot ($25\text{ }^{\circ}\text{C}$)
- are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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